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Citation: J. Appl. Phys. 107, 016102 (2010); doi: 10.1063/1.3275872

View online: http://dx.doi.org/10.1063/1.3275872

View Table of Contents: http://jap.aip.org/resource/1/JAPIAU/v107/i1

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Fully relaxed low-mismatched InAlAs layer on an InP substrate by using a two step buffer

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(Received 5 October 2009; accepted 24 November 2009; published online 7 January 2010)

The strain relaxation in low mismatched InAlAs layers has been studied by triple axis x-ray diffraction, transmission electron microscopy, and photoluminescence. Using a two step buffer, a fully relaxed top layer has been grown by adapting the composition and thickness of a first “strained layer.” The threading dislocation density in the top layer is below $10^6$/cm$^2$ and strain is relaxed at the substrate/first layer interface by misfit dislocations. This scheme is a promising method to limit the thickness of buffer layers and obtain fully relaxed pseudosubstrates. © 2010 American Institute of Physics. [doi:10.1063/1.3275872]

The use of the large range of electrical and optical properties of III–V semiconductors is often impeded by the lack of a proper substrate material with the desired lattice parameter. For large lattice mismatch, metamorphic growth has been developed extensively for two decades but small lattice mismatch has not received so much attention although needs indeed exist, concerning for instance application to semiconductor optical amplifiers (SOA).

In a standard pseudomorphic SOA on InP, a 0.1–0.15 μm thick InGaAs active layer is surrounded by a few tenths of microns thick InGaAsP layers. InGaAs is grown under a slight tensile strain $(1.5 \times 10^{-3})$ in order to get a polarization independent amplifier. In this case, the maximum working wavelength is around 1.62 μm. With increasing simultaneously transmitted data, the extension of the useful spectral region is of interest with SOAs working at 1.7 μm or above. This achievement requires an increase in the indium composition of the InGaAs layer toward 56%–57%. Together with the requirement to keep a tensile strained active region, this leads to a lattice mismatch between the whole structure (more than 1 μm thick) and the InP substrate around $3.5 \times 10^{-3}$. This latter value is no more compatible with a pseudomorphic growth and appeals for a metamorphic approach. More precisely, there is a need for a pseudosubstrate in which the elastic energy is greatly reduced by using a two-step buffer while the driving force for the creation of misfit dislocations is reduced. Indeed, both cases, the driving force for the creation of misfit dislocations, i.e., the elastic energy stored in the growing layer increases too slowly with thickness.

In this work, we show that by using a buffer layer of two InAlAs layers, with two different indium compositions, plastic relaxation can be greatly enhanced by the first high-indium content layer. The desired thickness of this first layer must be such that the corresponding partial relaxation leads to an in-plane lattice parameter which is the same as the InP one.

In highly mismatched structure $(\Delta a/a > 1.5 \times 10^{-2})$, fully relaxed InAlAs buffers have been achieved by the growth of graded layers in which the In content is gradually increased. This allows a progressive strain introduction which favors full plastic relaxation via misfit dislocations. However, this kind of buffer layer (Fig. 1(a)) is useless in low mismatched structures. In the same way, an InAlAs layer with a constant 58% In content does not fully relax until large thickness, hardly compatible with standard growth. Indeed, in both cases, the driving force for the creation of misfit dislocations, i.e., the elastic energy stored in the growing layer increases too slowly with thickness.

In this work, we show that by using a buffer layer of two InAlAs layers, with two different indium compositions (Fig. 1(b)), plastic relaxation can be greatly enhanced by the first high-indium content layer. The desired thickness of this first layer must be such that the corresponding partial relaxation leads to an in-plane lattice parameter which is the same as the InP one.

FIG. 1. Schematics of the variations in indium composition in metamorphic InAlAs buffers on InP(001): (a) graded ones and (b) two-step ones (this study).
relaxed one of the 58% In top layer. In this way, the following growth of the 58% In layer will be strain-free leading to a fully relaxed layer.

Samples used in this study were grown on 2 in. InP substrates by gas-source molecular beam epitaxy in a Riber 32P chamber. The arsenic flux was obtained by cracking arsine (AsH3) through a high-temperature injector, whereas standard effusion cells were used for group-III elements. The fluxes were calibrated using reflection high energy electron diffraction (RHEED) specular beam intensity oscillations on GaAs and InAs substrates. Samples were deoxidized under phosphorus flux at 525 °C. Structures were grown at 510 °C, with a V/III ratio between 2 and 3 and we observed a streaky (2 × 4) RHEED pattern all along the growth. The samples have been characterized by triple axis x-ray diffractometry and composition. To estimate the layer relaxation, the results of the lattice parameter relaxation and indium composition deduced from TA-XRD measurements on two 1 μm thick In0.34Al0.66As homogeneous buffer grown on a InP(001) substrate.

<table>
<thead>
<tr>
<th>Indium composition</th>
<th>Lattice parameter relaxation</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.58</td>
<td>0.32 0.34</td>
</tr>
<tr>
<td>0.62</td>
<td>0.57 0.53</td>
</tr>
</tbody>
</table>

FIG. 2. (Color online) Evolution of the top layer lattice parameter relaxation in the [110], [110], and [001] directions as a function of the first layer thickness. The In composition of the first layer is 0.66 whereas that of the top layer is 0.58, the total buffer thickness being 1 μm. Full lines are guide for eyes.
between the buffer layer and the substrate (around 3.5 \times 10^{-3}) full relaxation requires to relax 35 Å/µm along the interface. The above statements lead to a mean projection of the Burger vector in the interface plane of 3.5 Å. If we compare this value with the theoretical ones for 60° and the 90° misfit dislocations (respectively, 2.1 and 4.2 Å), it strongly suggests that the both types of dislocations are present at the interface.8-10

Finally, the interest of our buffer growth procedure for optical properties is demonstrated by the PL measurements in Fig. 4. For these measurements, three structures have been grown. The first one (curve A in Fig. 4) is a reference structure composed as follows: 0.5 µm InAlAs, 0.02 µm InP, 0.15 µm InGaAs, 0.02 µm InP, and 0.2 µm InAlAs, all alloys lattice-matched on InP. The two other structures are metamorphic ones with a tensile strained InGaAs well. The second structure (curve B in Fig. 4) makes use of a constant composition partially relaxed buffer layer: 1 µm In_{0.62}Al_{0.38}As, 0.02 µm InP, 0.15 µm In_{0.56}Ga_{0.43}As, 0.02 µm InP, and 0.2 µm In_{0.62}Al_{0.38}As. The third one (curve C in Fig. 4) uses the optimized buffer scheme: 0.17 µm In_{0.60}Al_{0.34}As, 0.83 µm In_{0.58}Al_{0.42}As, 0.02 µm InP, 0.15 µm In_{0.56}Ga_{0.43}As, 0.02 µm InP, and 0.2 µm In_{0.58}Al_{0.42}As. In each case, the InP thin layer is used to keep away the active InGaAs layer from Al-containing ones. First of all, we can confirm the correct wavelength of the structures above 1.7 µm. Then, a significant difference in PL intensity can be observed between the two metamorphic structures: it rises from 40% to 66% of the reference intensity when going from the constant composition buffer to the optimized one. This is a clear proof of the crystalline quality improvement in the active layer due to our optimized buffer scheme.

As a conclusion, we propose a new structure to relax the strain in low-mismatched layers without growing thick buffers. The full relaxation of the top buffer layer can be obtained by adapting the lattice parameter and the thickness of a partially strained first layer, what has been achieved in this study by growing a 0.17 µm thick In_{0.60}Al_{0.34}As layer before the growth of a fully relaxed In_{0.58}Al_{0.42}As one. TEM and XRD measurements evidence that strain is confined in the first layer and especially at the interface between the substrate and the buffer layer. The strain seems to be relaxed by both 60° and 90° misfit dislocations at this interface. The threading dislocation density in the top layer is below 10^{6}/cm^{2} and the PL measurements prove a significant increase in the crystalline quality using this scheme. In a more general way, we believe that this kind of approach can be applied each time a low-misfit structure has to be relaxed.

This research has been sponsored by the French National Research Agency (ANR), AROME (Grant No. 06 TCOM 034), the Region Nord-Pas de Calais, and the European Union.

FIG. 3. TEM of the buffer layer revealing misfit dislocations at the layer/substrate interface. No threading dislocation can be observed.

FIG. 4. (Color online) Influence of the buffer structure on PL measurements. Curve A is the PL response of a reference lattice-matched structure on InP. Curve B and C represent the PL measurement for a structure grown on a homogeneous In_{0.60}Al_{0.38}As layer and on an optimized buffer, respectively.